Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	98331	(photosensitive or photoresist or photolithographic or lithographic) same (resin or polymer or copolymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 07:39
L2	872	polybenzoxazole same (polyimide or hydroxypolyamide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 08:11
L3	228	1 and 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/19 08:12

## Refine Search Search Results -Terms Documents Jp-2002012665-\$.did. US Pre-Grant Publication Full-Text Database US Patents Full-Text Database US OCR Full-Text Database EPO Abstracts Database Database: JPO Abstracts Database **Derwent World Patents Index** IBM Technical Disclosure Bulletins L1Search: Refine Search Recall Text = Clear Interrupt Search History DATE: Friday, November 19, 2004 Printable Copy Create Case Set Name Query **Hit Count** Set Name side by side result set DB = PGPB, USPT, USOC, EPAB, JPAB, DWPI, TDBD; PLUR = YES; OP = ORL1Jp-2002012665-\$.did. <u>L1</u>

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**Search Results** - Record(s) 1 through 2 of 2 returned.

1. Document ID: <u>JP 2002012665</u> A

Using default format because multiple data bases are involved.

L1: Entry 1 of 2

File: JPAB

Jan 15, 2002

PUB-NO: JP02002012665A

DOCUMENT-IDENTIFIER: JP 2002012665 A

TITLE: PHOTOSENSITIVE RESIN AND COMPOSITION THEREOF

PUBN-DATE: January 15, 2002

INVENTOR-INFORMATION:

NAME

COUNTRY

KANEDA, TAKAYUKI KIMURA, MASASHI

KANETANI, RYUICHIRO

INT-CL (IPC):  $\underline{\text{C08}}$   $\underline{\text{G}}$   $\underline{73/22}$ ;  $\underline{\text{C08}}$   $\underline{\text{K}}$   $\underline{5/00}$ ;  $\underline{\text{C08}}$   $\underline{\text{L}}$   $\underline{79/06}$ ;  $\underline{\text{G03}}$   $\underline{\text{F}}$   $\underline{7/038}$ ;  $\underline{\text{G03}}$   $\underline{\text{F}}$   $\underline{7/40}$ ;  $\underline{\text{H01}}$   $\underline{\text{L}}$   $\underline{21/027}$ 

Full Title Citation Front Review Classification Date Reference Carponics Citation Claims KMC Draw De

2. Document ID: <u>JP 2002012665</u> A

L1: Entry 2 of 2

File: DWPI

Jan 15, 2002

DERWENT-ACC-NO: 2002-540892

DERWENT-WEEK: 200258

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TITLE: Photosensitive polybenzoxazole precursor resin preparation for insulating material of electronic parts, comprises reacting part of hydroxyl group in hydroxypolyamide with unsaturated double bond-having isocyanate compound

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Terms	Documents